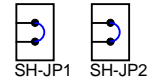


Orderable: N/A	Designed for: Public Release	Mod. Date: 2/15/2017
TID #: TIDA-01405	Project Title: TPS82130-1.8V Inverter	
Number: TIDA-01405	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By: Chris Glaser	File: TIDA-01405.SchDoc	Size: B
Engineer: Chris Glaser	Contact: http://www.ti.com/support	

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PCB Number: TIDA-01405
PCB Rev: E1



ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 2/9/2017	
TID #: TIDA-01405	Project Title: TPS82130-1.8V Inverter		
Number: TIDA-01405	Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2	
Drawn By:	File: TIDA-01405_Hardware.SchDoc	Size: B	
Engineer: Chris Glaser	Contact: http://www.ti.com/support		http://www.ti.com © Texas Instruments 2017

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